

N-CHANNEL ENHANCEMENT MODE MOSFET WITH SCHOTTKY DIODE POWERDI[®]

Product Summary

V _{(BR)DSS}	R _{DS(on) max}	I _D T _A = 25°C	
30V	13mΩ @ V _{GS} = 10V	10.2A	
300	16mΩ @ V _{GS} = 4.5V	9.3A	

Description

This new generation MOSFET has been designed to minimize the onstate resistance (R_{DS(on)}) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

Applications

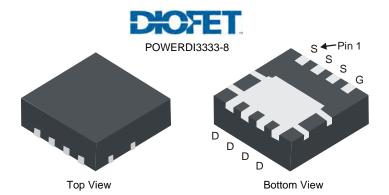
- DC-DC Converters
- Power management functions
- Analog Switch

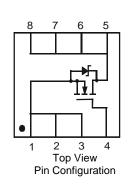
Features and Benefits

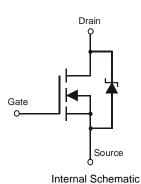
- DIOFET utilizes a unique patented process to monolithically integrate a MOSFET and a Schottky in a single die to deliver:
 - Low R_{DS(ON)} minimize conduction losses
 - Low V_{SD} reducing the losses due to body diode conduction
 - Low Q_{rr} lower Q_{rr} of the integrated Schottky reduces body diode switching losses
 - \bullet Low gate capacitance (Q $_{g}$ /Q $_{gs}$) ratio reduces risk of shootthrough or cross conduction currents at high frequencies
 - Avalanche rugged I_{AR} and E_{AR} rated
- Small form factor thermally efficient package enables higher density end products
- Occupies just 33% of the board area occupied by SO-8 enabling smaller end product
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case: POWERDI3333-8
- Case Material: Molded Plastic, "Green" Molding Compound.
- UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram
- Terminals: Finish Matte Tin annealed over Copper leadframe. Solderable per MIL-STD-202, Method 208
- Weight: 0.072 grams (approximate)







Ordering Information (Note 4)

Part Number	Case	Packaging
DMS3016SFG-7	POWERDI3333-8	2,000/Tape & Reel
DMS3016SFG-13	POWERDI3333-8	3,000/Tape & Reel

Notes:

- 1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.
- 2. See http://www.diodes.com for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + CI) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com.



Marking Information



S30 = Product Type Marking Code YYWW = Date Code Marking YY = Last digit of year (ex: 09 = 2009) WW = Week code (01 ~ 53)

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

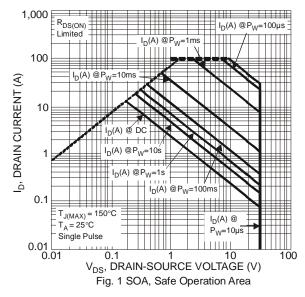
Characteristic	Symbol	Value	Units		
Drain-Source Voltage	V _{DSS}	30	V		
Gate-Source Voltage	V_{GSS}	±12	V		
Continuous Drain Current (Note 5) V _{GS} = 10V	Steady State	$T_A = +25^{\circ}C$ $T_A = +70^{\circ}C$	I _D	7.0 5.5	А
Continuous Drain Current (Note 5) V _{GS} = 4.5V	Steady State	$T_A = +25$ °C $T_A = +70$ °C	I _D	6.4 5.1	А
Continuous Drain Current (Note 6) V _{GS} = 10V	Steady State	$T_A = +25$ °C $T_A = +70$ °C	I _D	10.2 8.1	А
Continuous Drain Current (Note 6) V _{GS} = 4.5V	Steady State	$T_A = +25$ °C $T_A = +70$ °C	I _D	9.3 7.4	А
Pulsed Drain Current (10us pulse, duty cycle=1%)	I _{DM}	80	Α		
Avalanche Current (Note 7)	I _{AR}	13	Α		
Repetitive Avalanche Energy (Note 7) L = 0.3mH			E _{AR}	24	mJ

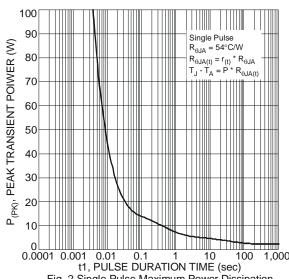
Thermal Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Units
Total Power Dissipation	(Note 5) (Note 6)	P _D	0.98 2.08	W
Thermal Resistance, Junction to Ambient	(Note 5) (Note 6)	$R_{ hetaJA}$	127 60	°C/W
Thermal Resistance, Junction to Case	(Note 6)	$R_{ heta JC}$	3.42	°C/W
Operating and Storage Temperature Range		T _J , T _{STG}	-55 to +150	°C

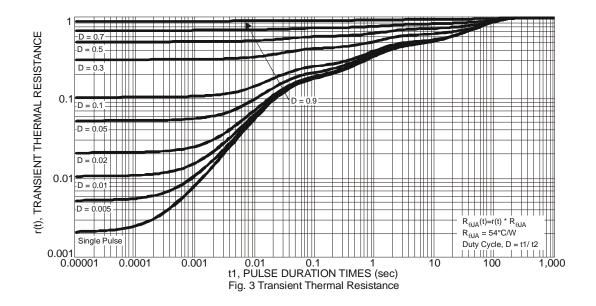
Notes:

- 5. Device mounted on FR-4 PC board, with minimum recommended pad layout, single sided.
- 6. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal vias to bottom layer 1 inch square copper plate
- 7 I_{AR} and E_{AR} rating are based on low frequency and duty cycles to keep T_J = +25°C









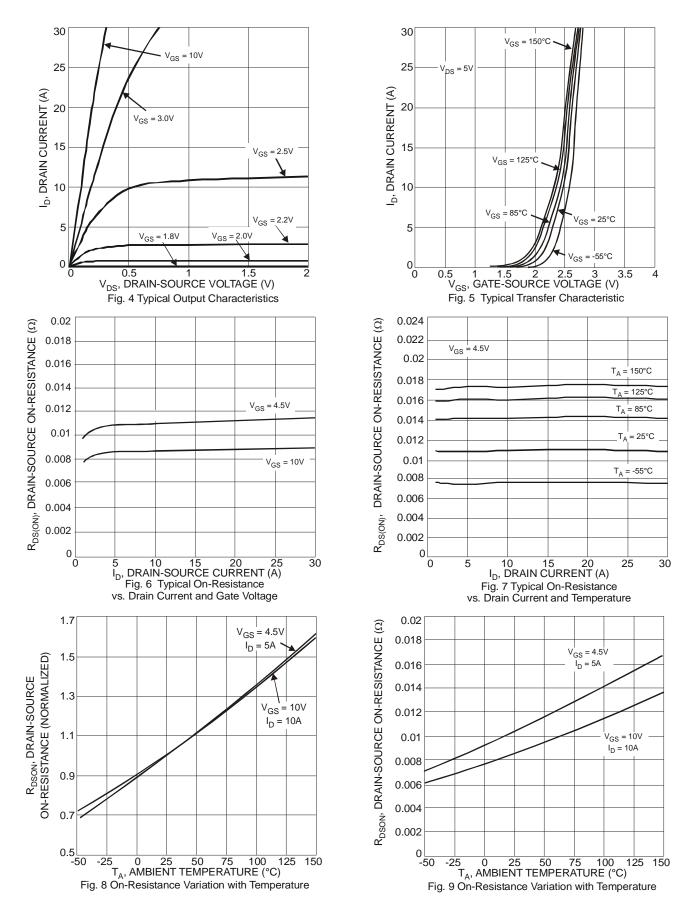
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

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Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 8)	1		1	1			
Drain-Source Breakdown Voltage	BV _{DSS}	30			V	$V_{GS} = 0V$, $I_D = 1mA$	
Zero Gate Voltage Drain Current	I _{DSS}	_	_	100	μΑ	$V_{DS} = 30V, V_{GS} = 0V$	
Gate-Source Leakage	IGSS	_	_	±100	nA	$V_{GS} = \pm 12V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 8)					_		
Gate Threshold Voltage	V _{GS(th)}	1.0	_	2.2	V	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	
Static Drain-Source On-Resistance		_	10	13	~ 0	$V_{GS} = 10V, I_D = 11.2A$	
Static Dialit-Source Off-Resistance	R _{DS(ON)}	_	12	16	mΩ	$V_{GS} = 4.5V, I_D = 10.A$	
Forward Transfer Admittance	Y _{fs}	_	25	_	S	$V_{DS} = 5V$, $I_{D} = 11.2A$	
Diode Forward Voltage	V_{SD}	_	0.37	0.6	V	$V_{GS} = 0V, I_{S} = 1A$	
Maximum Body-Diode + Schottky Continuous Current	Is	_	_	5	Α		
DYNAMIC CHARACTERISTICS (Note 9)			_	_	_		
Input Capacitance	C _{iss}	_	1886	_		V _{DS} = 15V, V _{GS} = 0V f = 1.0MHz	
Output Capacitance	Coss	_	372	_	pF		
Reverse Transfer Capacitance	C_{rss}	_	128	_			
Gate Resistance	R_{G}	_	2.0	_	Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1.0MHz$	
Total Gate Charge (V _{GS} = 4.5V)	Q_g	_	19.5	_			
Total Gate Charge (V _{GS} = 10V)	Q_g	_	44.6	_	nC	$V_{DS} = 15V, V_{GS} = 10V$ $I_{D} = 11.2A$	
Gate-Source Charge	Q_{gs}	_	4.8	_	IIC		
Gate-Drain Charge	Q_{gd}	_	4.6	_			
Turn-On Delay Time	t _{D(on)}	_	5.8	_			
Turn-On Rise Time	t _r	_	23.7	_	ns	$V_{GS} = 10V, V_{DD} = 15V, R_G = 3\Omega,$	
Turn-Off Delay Time	t _{D(off)}	_	35.4	_	115	$R_L = 1.2\Omega$	
Turn-Off Fall Time	t _f	_	7.7	_			

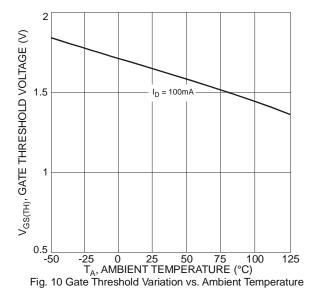
Notes:

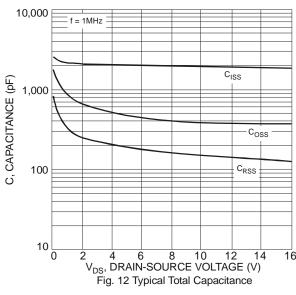
- 8 .Short duration pulse test used to minimize self-heating effect.
- 9. Guaranteed by design. Not subject to production testing.

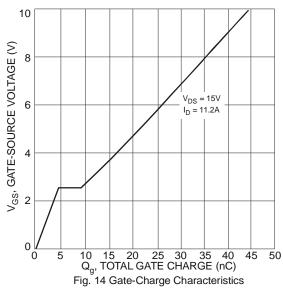


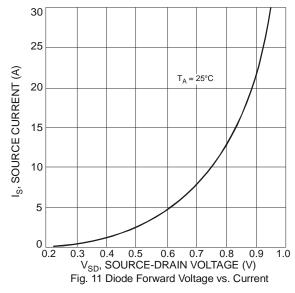












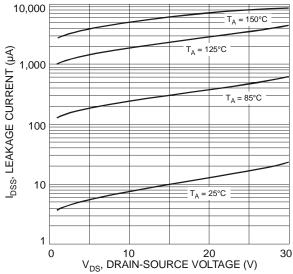
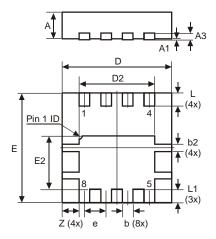


Fig. 13 Typical Drain-Source Leakage Current vs. Voltage



Package Outline Dimensions

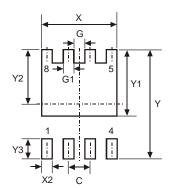
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



P	POWERDI3333-8					
Dim	Min	Max	Тур			
D	3.25	3.35	3.30			
E	3.25	3.35	3.30			
D2	2.22	2.32	2.27			
E2	1.56	1.66	1.61			
Α	0.75	0.85	0.80			
A1	0	0.05	0.02			
А3	_	-	0.203			
b	0.27	0.37	0.32			
b2	_	_	0.20			
L	0.35	0.45	0.40			
L1	_	_	0.39			
е	_	_	0.65			
Z	_	_	0.515			
All I	All Dimensions in mm					

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
С	0.650
G	0.230
G1	0.420
Υ	3.700
Y1	2.250
Y2	1.850
Y3	0.700
Х	2.370
X2	0.420



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